

AR/17w



April 13, 2006

To: Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Fr: Stephen B. Ackerman, Reg. No. 37,761
28 Davis Avenue
Poughkeepsie, N.Y. 12603

Subject:

Serial No. 10/802,563 03/17/04

Hong Yu Yu et al

"A THERMAL ROBUST SEMICONDUCTOR
DEVICE USING HFN AS METAL GATE
ELECTRODE AND THE MANUFACTURING
PROCESS THEREOF"

Grp. Art Unit: 2823

SU C. KIM

RESPONSE FINAL PATENT OFFICE ACTION

Dear Sir:

In response to the Final Office Action dated March 10, 2006, please consider the following remarks concerning the above-identified application for patent:

CERTIFICATE OF MAILING

I hereby certify that this correspondence is being deposited with the United States Postal Service as first class mail in an envelope addressed to: Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450, on May 3, 2006.

Rosemary L. S. Pike, Reg # 39,332

Signature

Date

5/3/06

Amendments to the Claims are reflected in the listing of the Claims which begins on page 3 of this paper.

Remarks/Arguments begin on page 11 of this paper.